

## **Applications**

- General purpose wireless
- Femtocells
- Repeaters
- Data cards and dongles

#### **Product Features**

- Usable bandwidth 25 MHz
- No matching required for operation at  $50\Omega$
- Excellent rejection for Bluetooth and GPS operation
- Suitable for Automotive applications Compliant to the AEC-Q200 reliability standard. Manufacturing facilities are certified with ISO/TS 16949:2002
- High Isolation
- High Rejection
- Ceramic Surface Mount Package (SMP)
- Small Size: 3.8 x 3.8 x 1.47 mm
- Hermetic RoHS compliant, Pb-free

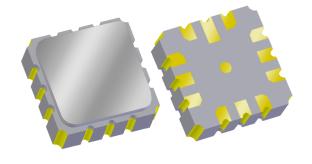


#### **General Description**

856908 is a Band V duplexer in a compact size for use in Femtocells, coverage enhancement repeaters, data cards, and other wireless data applications. Designed for rejection of unwanted Bluetooth and GPS signals, this SAW duplexer also has excellent power handling capability for low power transmitters.

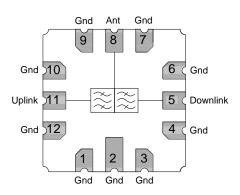
Housed in a 3.8 x 3.8 mm hermetic package, this device allows for a compact and cost effective duplexer solution for Band V applications.

No matching components are required, making the PCB design and implementation easy.



#### **Functional Block Diagram**

Top view



## **Pin Configuration**

Pin # SE	Description
5	Downlink
8	Antenna
11	Uplink
1,2,3,4,6	Case Ground
7,9,10,12	Case Ground

## Ordering Information

Part No.	Description
856908	packaged part
856908-EVB	evaluation board

Standard T/R size =4000 units/reel.

- 1 of 8 -



# **Specifications**

# Electrical Specifications (1)

Specified Temperature Range: (2) -30 to +85 °C

Uplink Specifications					
Parameter (3)	Conditions	Min	Typical (4)	Max	Units
Center Frequency		-	836.5	-	MHz
Maximum Insertion Loss	824 – 849 MHz	-	2.0	2.5	dB
Amplitude Ripple	824 – 849 MHz	-	0.25	1.0	dB p-p
Absolute Attenuation	869 – 894 MHz	42.5	44.7	-	dB
	1574 – 1577 MHz	38	42.4	-	dB
	1648 – 1698 MHz	35	45	-	dB
	1850 – 2170 MHz	27	35.7	-	dB
	2472 – 2547 MHz	15	22.6	-	dB
Return Loss at Uplink Terminal (5)	824 – 849 MHz	9.5	12	-	dB
Input Power (6)	824 – 849 MHz			+27	dBm

Downlink Specifications					
Parameter (3)	Conditions	Min	Typical (4)	Max	Units
Center Frequency		-	881.5	-	MHz
Maximum Insertion Loss	869 – 894 MHz	-	2.5	3.5	dB
Amplitude Ripple	869 – 894 MHz	-	0.4	2.2	dB p-p
Absolute Attenuation	824 – 849 MHz	50	55.3	-	dB
	1570 – 1580 MHz	40	56.0	-	dB
	1850 – 2170 MHz	33	41.0	-	dB
	2400 – 2484 MHz	15	23.4	-	dB
Return Loss at Downlink Terminal (5)	869 – 894 MHz	9.5	10.8	-	dB
Input Power (6)	869 – 894 MHz			+24	dBm

Uplink-Downlink Specifications					
Parameter (3)	Conditions	Min	Typical (4)	Max	Units
Uplink-Downlink Isolation	824 – 849 MHz	50	56.9	-	dB
	849 – 869 MHz	34	38.4	-	dB
	869 – 894 MHz	45	46.4	-	dB
Source/Load Impedance (single-ended) (7)		-	50	-	Ω

#### Notes:

- 1. All specifications are based on the TriQuint schematics for the reference designs shown on page 4
- 2. In production, devices will be tested at room temperature to a guardbanded specification to ensure electrical compliance over temperature
- 3. Electrical margin has been built into the design to account for the variations due to temperature drift and manufacturing tolerances
- 4. Typical values are based on average measurements at room temperature on pcb
- 5. Excluding losses due to PCB
- 6. CW signal at 55°C for 10,000 hours
- 7. This is the optimum impedance in order to achieve the performance shown

# **Absolute Maximum Ratings**

Parameter	Rating
Operable Temperature	$-40 \text{ to } +85 ^{\circ}\text{C}$
Storage Temperature	$-40 \text{ to } +85 ^{\circ}\text{C}$

Operation of this device outside the parameter ranges given above may cause permanent damage.

Data Sheet: Rev H 10/25/12 - 2 of 8 - Disclaimer: Subject to change without notice



# **Specifications**

# **Electrical Specifications** (1)

Specified Temperature Range: (2) -40 to +85 °C

Uplink Specifications					
Parameter (3)	Conditions	Min	Typical (4)	Max	Units
Center Frequency		-	836.5	-	MHz
Maximum Insertion Loss	824 – 849 MHz	-	2.0	2.9	dB
Amplitude Ripple	824 – 849 MHz	-	0.25	1.0	dB p-p
Absolute Attenuation	869 – 894 MHz	42.5	44.7	-	dB
	1574 – 1577 MHz	37.5	42.4	-	dB
	1648 – 1698 MHz	35	45	-	dB
	1850 – 2170 MHz	27	35.7	-	dB
	2472 – 2547 MHz	15	22.6	-	dB
Return Loss at Uplink Terminal (5)	824 – 849 MHz	9.3	12	-	dB
Input Power (6)	824 – 849 MHz			+27	dBm

Downlink Specifications					
Parameter (3)	Conditions	Min	Typical (4)	Max	Units
Center Frequency		-	881.5	-	MHz
Maximum Insertion Loss	869 – 894 MHz	-	2.5	3.9	dB
Amplitude Ripple	869 – 894 MHz	-	0.4	2.2	dB p-p
Absolute Attenuation	824 – 849 MHz	50	55.3	-	dB
	1570 – 1580 MHz	40	56.0	-	dB
	1850 – 2170 MHz	33	41.0	-	dB
	2400 – 2484 MHz	15	23.4	-	dB
Return Loss at Downlink Terminal (5)	869 – 894 MHz	9.5	10.8	-	dB
Input Power (6)	869 – 894 MHz			+24	dBm

Uplink-Downlink Specifications					
Parameter (3)	Conditions	Min	Typical (4)	Max	Units
Uplink-Downlink Isolation	824 – 849 MHz	50	56.9	-	dB
	849 – 869 MHz	34	38.4	-	dB
	869 – 894 MHz	45	46.4	-	dB
Source/Load Impedance (single-ended) (7)		-	50	-	Ω

#### Notes:

- 1. All specifications are based on the TriQuint schematics for the reference designs shown on page 4
- 2. In production, devices will be tested at room temperature to a guardbanded specification to ensure electrical compliance over temperature
- 3. Electrical margin has been built into the design to account for the variations due to temperature drift and manufacturing tolerances
- 4. Typical values are based on average measurements at room temperature on pcb
- 5. Excluding losses due to PCB
- 6. CW signal at 55°C for 10,000 hours
- 7. This is the optimum impedance in order to achieve the performance shown

### **Absolute Maximum Ratings**

Parameter	Rating
Operable Temperature	$-40 \text{ to } +85 ^{\circ}\text{C}$
Storage Temperature	$-40 \text{ to } +85 ^{\circ}\text{C}$

Operation of this device outside the parameter ranges given above may cause permanent damage.

Data Sheet: Rev H 10/25/12 - 3 of 8 - Disclaimer: Subject to change without notice

Connecting the Digital World to the Global Network



## Reference Design $-50\Omega$ SE Input, $50\Omega$ SE Output

#### **Schematic**

ANT **Uplink**  $50 \Omega$ ≶50Ω 1,2,3,4,6 Single-ended ≷50Ω 7,9,10,12 Input ANT **Downlink**  $50 \Omega$ ≶50Ω \$50Ω 1,2,3,4,6 Single-ended 7,9,10,12 Input

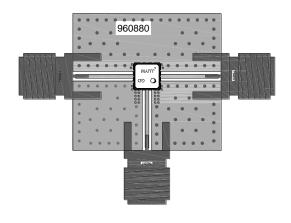
 $\begin{array}{c} 50~\Omega\\ Single-ended\\ Output \end{array}$ 

 $\begin{array}{c} 50\,\Omega\\ Single-ended\\ Output \end{array}$ 

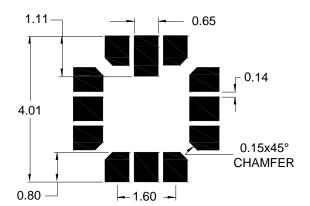
#### Notes:

- 1. No impedance matching required
- 2. Actual matching values may vary due to PCB layout and parasitic

#### **PC Board**



## **Mounting Configuration**



#### Notes:

Top, middle & bottom layers: 1 oz copper Substrates: FR4 dielectric, .031" thick

Finish plating: Nickel: 3-8µm thick, Gold: .03-.2µm thick

Hole plating: Copper min .0008µm thick

#### Notes:

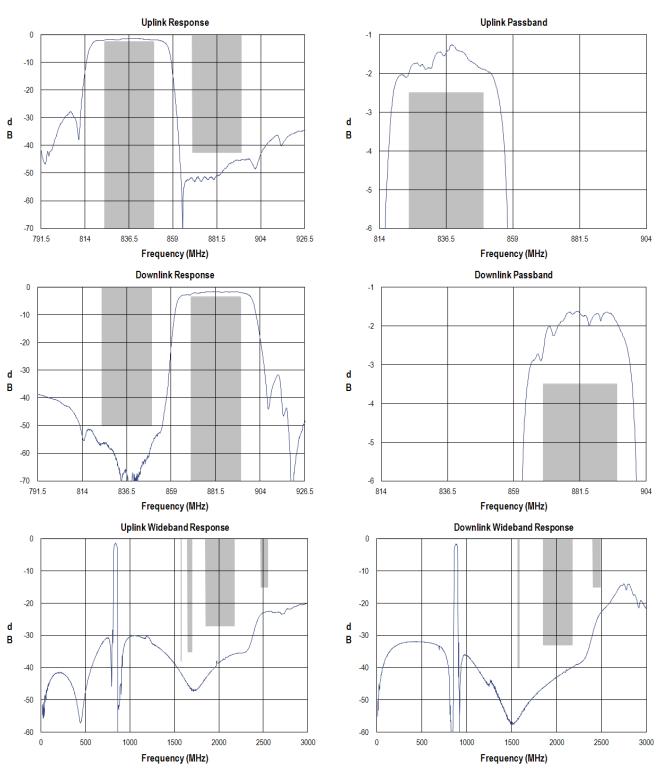
- 1. All dimensions are in millimeters.
- 2. This footprint represents a recommendation only.

#### **Bill of Material**

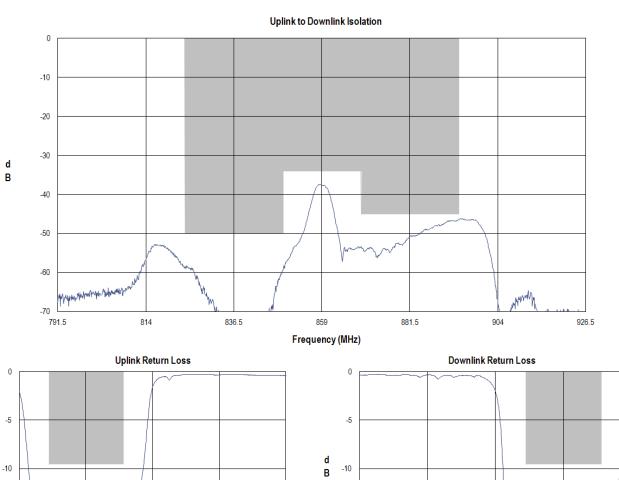
Reference Desg.	Value	Description	Manufacturer	Part Number
SMA	N/A	SMA connector	Radiall USA Inc.	9602-1111-018
PCB	N/A	3-layer	multiple	960880

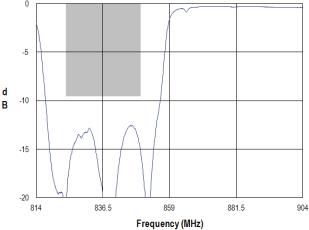


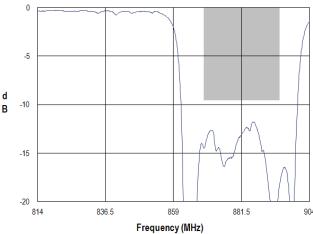
# Typical Performance (at room temperature)







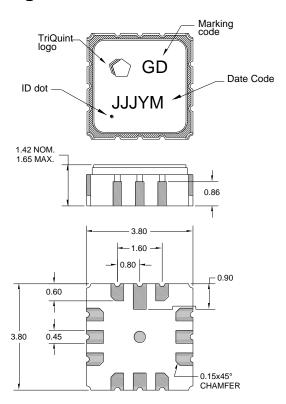






### **Mechanical Information**

## **Package Information, Dimensions and Marking**



Package Style: SMP-15N Dimensions: 3.8 x 3.8 x 1.42 mm

Body:  $Al_2O_3$  ceramic Lid: Kovar, Ni plated

Terminations: Au plating 0.5 - 1.0μm, over a 2-6μm Ni

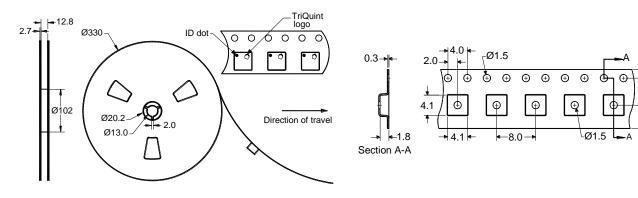
plating

All dimensions shown are nominal in millimeters All tolerances are  $\pm 0.15 mm$  except overall length and width  $\pm 0.10 mm$ 

The date code consists of: day of the current year (Julian, 3 digits),  $Y = last\ digit\ of\ the\ year$ , and  $M = manufacturing\ site\ code$ 

## **Tape and Reel Information**

Standard T/R size = 4000 units/reel. All dimensions are in millimeters



- 7 of 8 -



#### **Product Compliance Information**

#### **ESD Information**



#### **Caution! ESD-Sensitive Device**

ESD Rating: 1A

Value: Passes ≥ 300 V min.

Test: Human Body Model (HBM)

Standard: JEDEC Standard JESD22-A114

ESD Rating: B

Value: Passes  $\geq 200 \text{ V min.}$ Test: Machine Model (MM)

Standard: JEDEC Standard JESD22-A115

### **MSL Rating**

Devices are Hermetic, therefore MSL is not applicable

#### **Solderability**

Compatible with the latest version of J-STD-020, lead free solder, 260°C

Refer to **Soldering Profile** for recommended guidelines.

This part is compliant with EU 2002/95/EC RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment).

This product also has the following attributes:

- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A  $(C_{15}H_{12}Br_4O_2)$  Free
- PFOS Free
- SVHC Free

#### **Contact Information**

For the latest specifications, additional product information, worldwide sales and distribution locations, and information about TriQuint:

Web: <u>www.triquint.com</u> Tel: +1.407.886.8860 Email: <u>info-sales@tgs.com</u> Fax: +1.407.886.7061

For technical questions and application information:

Email: flapplication.engineering@tqs.com

## **Important Notice**

The information contained herein is believed to be reliable. TriQuint makes no warranties regarding the information contained herein. TriQuint assumes no responsibility or liability whatsoever for any of the information contained herein. TriQuint assumes no responsibility or liability whatsoever for the use of the information contained herein. The information contained herein is provided "AS IS, WHERE IS" and with all faults, and the entire risk associated with such information is entirely with the user. All information contained herein is subject to change without notice. Customers should obtain and verify the latest relevant information before placing orders for TriQuint products. The information contained herein or any use of such information does not grant, explicitly or implicitly, to any party any patent rights, licenses, or any other intellectual property rights, whether with regard to such information itself or anything described by such information.

TriQuint products are not warranted or authorized for use as critical components in medical, life-saving, or life-sustaining applications, or other applications where a failure would reasonably be expected to cause severe personal injury or death.

Data Sheet: Rev H 10/25/12 © 2012 TriQuint Semiconductor, Inc. - 8 of 8 - Disclaimer: Subject to change without notice

# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Signal Conditioning category:

Click to view products by Qorvo manufacturer:

Other Similar products are found below:

MAPDCC0001 MAPDCC0004 PD0409J5050S2HF 880157 HHS-109-PIN DC1417J5005AHF AFS14A30-2185.00-T3 AFS14A35-1591.50-T3 DS-323-PIN B39321R801H210 1A0220-3 JP510S LFB212G45SG8C341 LFB322G45SN1A504 LFL182G45TC3B746 SF2159E 30057 FM-104-PIN CER0813B MAPDCC0005 3A325 40287 41180 ATB3225-75032NCT BD0810N50100AHF BD2425J50200AHF C5060J5003AHF JHS-115-PIN JP503AS DC0710J5005AHF DC2327J5005AHF DC3338J5005AHF 43020 LFB2H2G60BB1C106 LFL15869MTC1B787 X3C19F1-20S XC3500P-20S 10013-20 SF2194E CDBLB455KCAX39-B0 TGL2208-SM, EVAL RF1353C 1E1305-3 1F1304-3S 1G1304-30 B0922J7575AHF 2020-6622-20 10017-3 TP-103-PIN BD1222J50200AHF